



T77P2500S Series

6500 V_{RMS}, 800 A_{AVG}
Standard Recovery Thyristor

Features:

- All Diffused Structure
- Linear Amplifying Gate Configuration
- Blocking capability up to 2100 volts
- Guaranteed Maximum Turn-Off Time
- High dV/dt Capability
- Pressure Assembled Device



ELECTRICAL CHARACTERISTICS AND RATINGS

Blocking - Off State

Device Type	V _{RRM} ⁽¹⁾	V _{DRM} ⁽¹⁾	V _{RSM} ⁽¹⁾
T77P2500S1200	1200	1200	1300
T77P2500S1400	1400	1400	1500
T77P2500S1600	1600	1600	1700
T77P2500S1800	1800	1800	1900
T77P2500S2000	2000	2000	2100
T77P2500S2100	2100	2100	2200
T77P2500S2400	2400	2400	2500

V_{RRM} = Repetitive peak reverse voltage

V_{DRM} = Repetitive peak off state voltage

V_{RSM} = Non repetitive peak reverse voltage⁽²⁾

Repetitive peak reverse leakage and off state leakage	I _{RRM} / I _{DRM}	10 mA 150 mA ⁽³⁾
Critical rate of voltage rise	dV/dt ⁽⁴⁾	500 V/μsec

Conducting - On State

Parameter	Symbol	Min.	Max.	Typ.	Units	Conditions
Average value of on-state current	I _{T(AV)}		2500		A	Sinewave, 180° conduction, T _C =65°C
RMS value of on-state current	I _{TRMS}		3925		A	Nominal value
Peak one cycle surge (non-repetitive) current	I _{TSM}		45000		A	8.3 msec (60Hz), sinusoidal wave-shape, 180° conduction, T _J = 125°C
			41500		A	10.0 msec (50Hz), sinusoidal wave-shape, 180° conduction, T _J = 125°C
I square t	I ² t		8.5x10 ⁶		A ² s	8.3 msec and 10.0 msec
Latching current	I _L		400		mA	V _D = 24 V; R _L = 12 ohms
Holding current	I _H		100		mA	V _D = 24 V; I = 2.5 A

Notes:

All ratings are specified for T_J=25°C unless otherwise stated.

(1) All voltage ratings are specified for an applied 50Hz/60Hz sinusoidal waveform over the temperature range -40 to +125°C.

(2) 10 msec. max. pulse width

(3) Maximum value for T_J = 125°C.

(4) Minimum value for linear and exponential waveshape to 80% rated V_{DRM}. Gate open. T_J = 125°C.

(5) Non-repetitive value.

(6) The value of di/dt is established in accordance with EIA/NIMA Standard RS-397, Section 5-2-2-6. The value defined would be in addition to that obtained from a snubber circuit, comprising a 0.2 μF capacitor and 20 ohms resistance in parallel with the thyristor under test.



Peak on-state voltage	V_{TM}		1.90		V	$I_{TM} = 7850 \text{ A}$; Duty cycle $\leq 0.01\%$
Maximum Forward Current	I_{FM}		7850		A	
Critical rate of rise of on-state current ^(5, 6)	di/dt		300		A/ μs	Switching from $V_{DRM} \leq 1000 \text{ V}$, non-repetitive
Critical rate of rise of on-state current ⁽⁶⁾	di/dt		100		A/ μs	Switching from $V_{DRM} \leq 1000 \text{ V}$

Gating

Parameter	Symbol	Min.	Max.	Typ.	Units	Conditions
Peak gate power dissipation	P_{GM}		200		W	$t_p = 40 \mu\text{s}$
Average gate power dissipation	$P_{G(AV)}$		5		W	
Peak gate current	I_{GM}		15		A	
Gate current required to trigger all units	I_{GT}		300 200 125		mA mA mA	$V_D = 6 \text{ V}$; $R_L = 3 \text{ ohms}$; $T_J = -40^\circ\text{C}$ $V_D = 6 \text{ V}$; $R_L = 3 \text{ ohms}$; $T_J = +25^\circ\text{C}$ $V_D = 6 \text{ V}$; $R_L = 3 \text{ ohms}$; $T_J = +125^\circ\text{C}$
Gate voltage required to trigger all units	V_{GT}	0.30	5 4		V V V	$V_D = 6 \text{ V}$; $R_L = 3 \text{ ohms}$; $T_J = -40^\circ\text{C}$ $V_D = 6 \text{ V}$; $R_L = 3 \text{ ohms}$; $T_J = 0-125^\circ\text{C}$ $V_D = \text{Rated } V_{DRM}$; $R_L = 1000 \text{ ohms}$; $T_J = +125^\circ\text{C}$
Peak negative voltage	V_{GRM}		15		V	

Dynamic

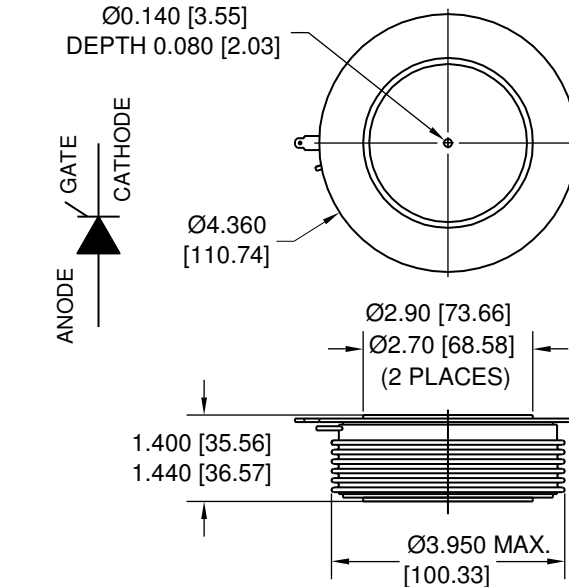
Parameter	Symbol	Min.	Max.	Typ.	Units	Conditions
Delay time	t_d		3.0	2.5	μs	$I_{TM} = 50 \text{ A}$; $V_D = 1500 \text{ V}$ Gate pulse: $V_G = 20 \text{ V}$; $R_G = 20 \text{ ohms}$; $t_r = 0.1 \mu\text{s}$; $t_p = 20 \mu\text{s}$
Turn-off time (with $V_R = -50 \text{ V}$)	t_q		400	250	μs	$I_{TM} > 2000 \text{ A}$; $di/dt = 10 \text{ A}/\mu\text{s}$; $V_R \geq -50 \text{ V}$; Re-applied $dV/dt = 20 \text{ V}/\mu\text{s}$ linear to $80\% V_{DRM}$; $V_G = 0$; $T_J = 125^\circ\text{C}$; Duty cycle $\geq 0.01\%$
Reverse recovery current	I_{rr}		200		A	$I_{TM} > 2000 \text{ A}$; $di/dt = 10 \text{ A}/\mu\text{s}$; $V_R \geq -50 \text{ V}$

THERMAL AND MECHANICAL CHARACTERISTICS AND RATINGS

Parameter	Symbol	Min.	Max.	Typ.	Units	Conditions
Operating temperature	T _J	-40	+125		°C	
Storage temperature	T _{STG}	-40	+150		°C	
Thermal resistance – junction to case	R _{Θ(j-c)}		0.012		°C/W	Double sided cooled Single sided cooled
Thermal resistance – case to sink	R _{Θ(c-s)}		0.002		°C/W	Double sided cooled * Single sided cooled *
Mounting force	P	8000 35.5	10000 44.4		lb. kN	
Weight	W			3.5 1.60	Lb. Kg.	

*Mounting surfaces smooth, flat and greased

CASE OUTLINE AND DIMENSIONS



DIMENSIONS IN INCHES [MM]